

IEEE 開放取用與 2024 投稿優惠詳解

主要內容

- 如何提高自己科研的可見度和影響力
- 在IEEE期刊發表開放取用文章的益處
- IEEE 2023 OA 投稿優惠詳解與實踐流程

如何提高自己科研的可見度和影響力

問題提出

發表論文

研究實施與結果收集

完整科研流程應該包含哪些步驟？

研究設計

推廣研究

文獻調研

撰寫論文

在科研全流程提升研究可見度

- 清晰簡潔的標題，突出讀者可能的興趣點
- 精准、標準化的關鍵字
- 建立自己的學術檔案（IEEE Xplore作者頁面, ORCID等）
- 將論文提交給有影響力的學術機構發表
- 參加學術會議/研討會展示研究成果
- 多途徑推廣學術成果
- 以OA形式發表研究成果
- 分享研究相關代碼、資料等相關材料

IEEE Xplore 作者页面



Winnie N. Ye  

Also published under: Winnie Ye, W. N. Ye, W. Ye

作者姓名消歧

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Affiliation

Department of Electronics
1125 Colonel By Drive
Carleton University, Ottawa, Canada

Publication Topics

integrated optics, diffraction gratings, silicon, elemental semiconductors, optical waveguides, silicon-on-insulator, integrated optoelectronics, optical communication equipment, beam steering, demultiplexing, micro-optics, optical

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Biography

Winnie N. Ye (Senior Member, IEEE) received the B.Eng. degree in electrical engineering from Carleton University, Ottawa, ON, Canada, the M.A.Sc. degree in photonics from the University of Toronto, Toronto, ON, and the Ph.D. degree in photonics from Carleton University. She is currently a Full Professor with the

Publications

52

Citations?

338

Publications by Year



Co-Authors:

Sawsan Abdul-Majid
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名稱

Winnie N. Ye

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投稿人: Daniel Benedikovič; Qiankun Liu; Alejandro Sánchez-Postigo; Ahmad Atieh; Tom Smy; Pavel Cheben; Winnie N. Ye

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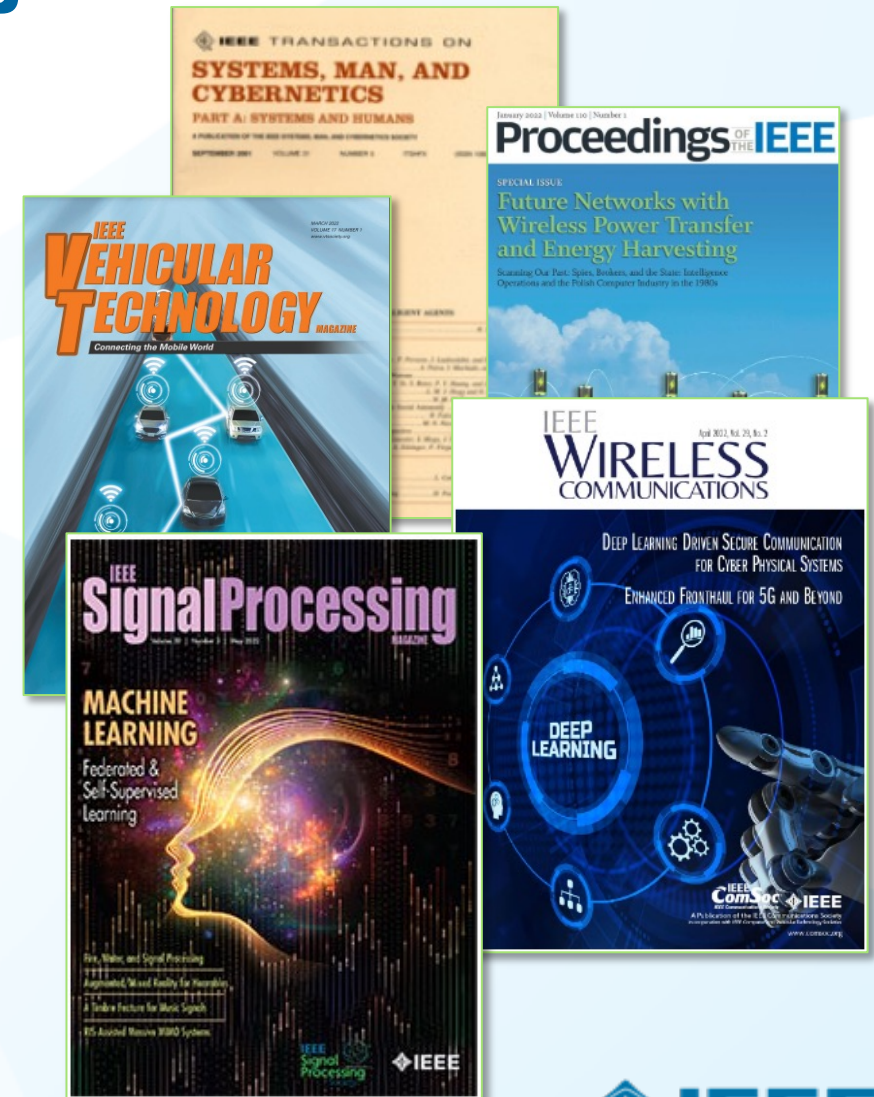
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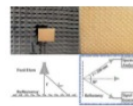
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Electronic ISSN: 2169-3536

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▶ Funding Agency:



Architecture of the EyeFundusScopeNEO system.

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A Mobile Tele-Ophthalmology System for Planned and Opportunistic Screening of Diabetic Retinopathy in Primary Care

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Authors Francisco Nunes; Pedro Madureira; Sílvia Rêgo; Cristiana Braga; Rúben Moutinho; Tiago Oliveira; Filipe Soares

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Hearing aids have been around for a long time, yet there is still much dissatisfaction with their performance. A recent post asked "Will hearing aids ever be as effective as corrective eyewear?"

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Institutional Announcement: Journal Article Publication

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- Author's job title
- University/company affiliation
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- Title of journal or magazine
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 - How it will impact humanity or our everyday lives

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DATELINE, DATE -- Researchers at [organization name] have published their findings on [Area of technology researched (non-technical description) and why it matters] in the latest issue of [IEEE Journal Name, or IEEE Access]. IEEE is the world's largest technical professional organization advancing technology for humanity.

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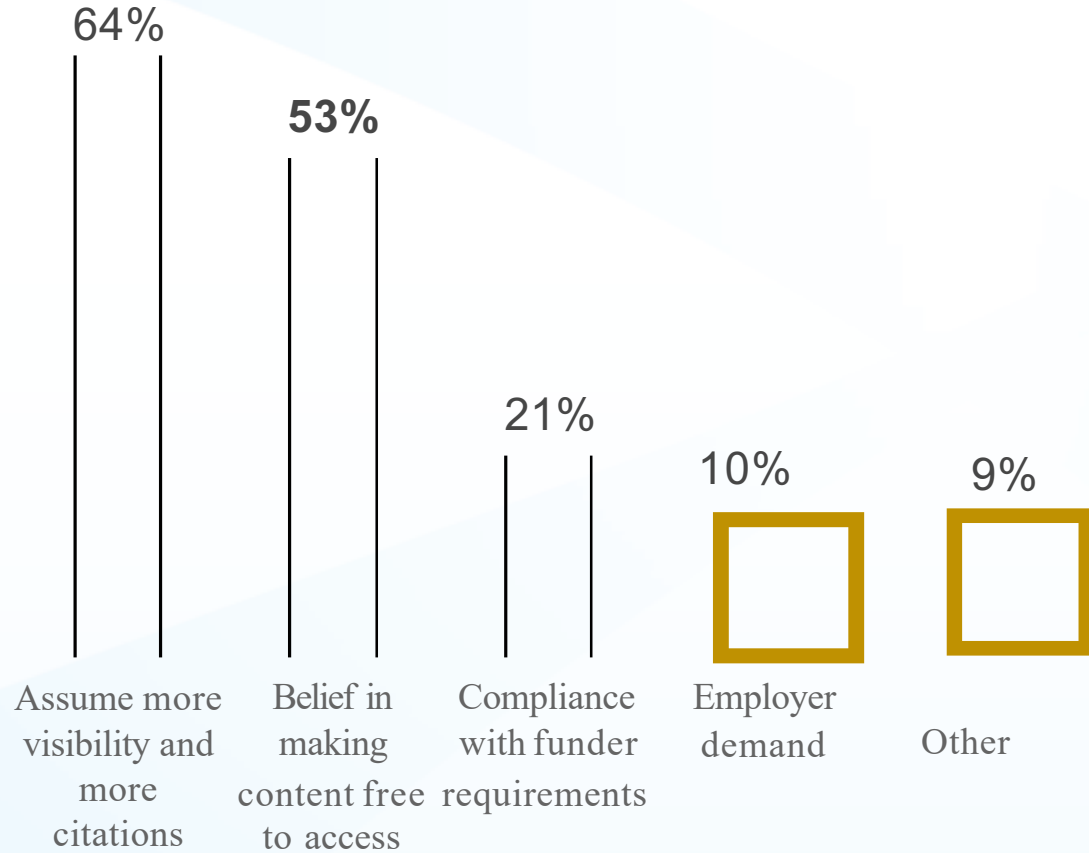
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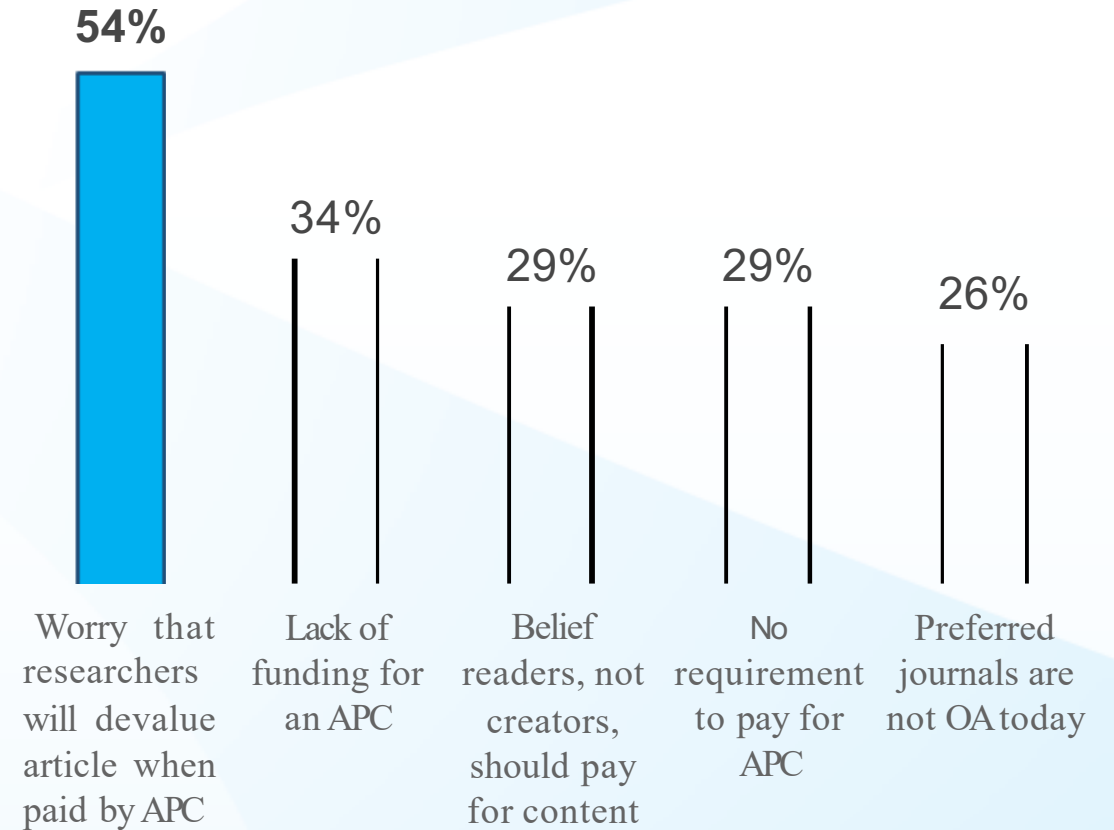
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2021 IEEE作者調查

Those preferring fully OA journals



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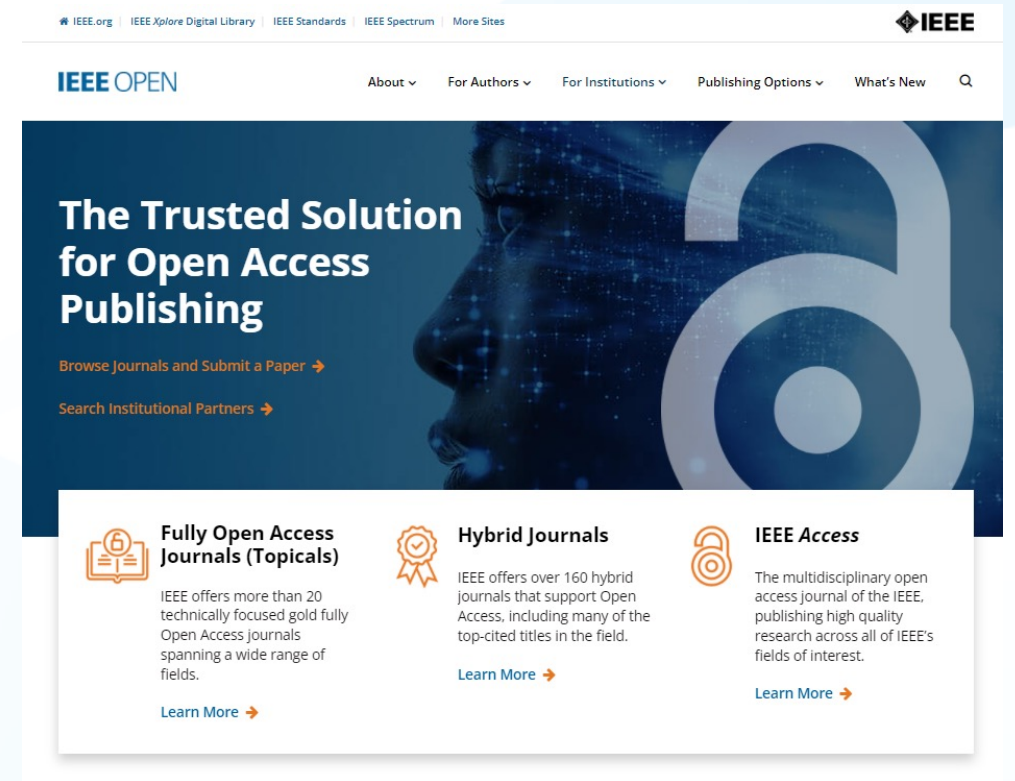
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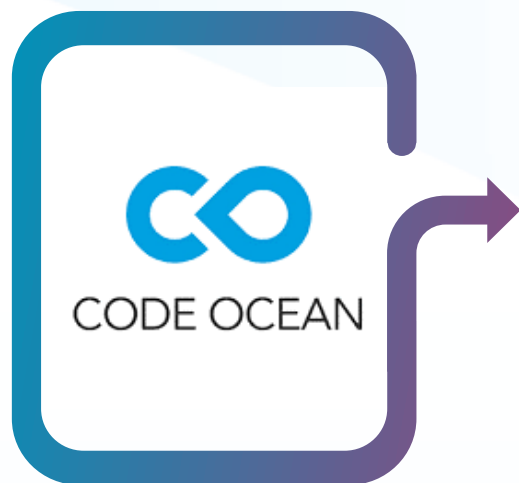


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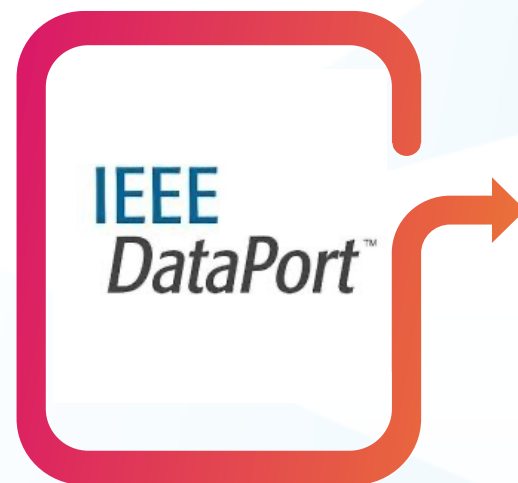
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Index Modulation Based Coordinate Interleaved Orthogonal Design for Secure Communications

Publisher: IEEE

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PDF



Burak Ozpoyraz ; Ibrahim Yildirim ; Ertugrul Basar All Authors

文章細節頁面

Abstract

Abstract:

Document Sections

- I. Introduction
- II. System Model
- III. Performance Analysis
- IV. Simulation Results
- V. Conclusion

In this paper, we propose a physical layer security scheme that exploits a novel index modulation (IM) technique for coordinate interleaved orthogonal designs (CIOD). Utilizing the diversity gain of CIOD transmission, the proposed scheme, named CIOD-IM, provides an improved spectral efficiency by means of IM. In order to provide a satisfactory secrecy rate, we design a particular artificial noise matrix, which does not affect the performance of the legitimate receiver, while deteriorating the performance of the eavesdropper. We derive expressions of the ergodic secrecy rate and the theoretical bit error rate upper bound. In addition, we analyze the case of imperfect channel estimation by taking practical concerns into consideration. It is shown via computer simulations that the proposed scheme outperforms the existing IM-based schemes and might be a candidate for future secure communication systems.

Code & Datasets

Code Dataset

This article includes code hosted on Code Ocean, a computational reproducibility platform that allows users to view, modify, run, and download code included with IEEE Xplore articles. NOTE: A Code Ocean user account is required to access functionality in the capsule below.

Code: MATLAB Index Modulation Based Coordinate Interleaved Orthogonal Designs

```
Index Modulation Based Coordinate Interleaved Ort... (Burak Ozpoyraz, Ibra...)  
1 clear all;  
2 clc;  
3  
4 num_iterations = 1e4;  
5 N = 4;  
6 M = 4;  
7 P_tot_des = 1;  
8 alpha = 0.5;  
9 sigma2 = 0;  
10 SNRdB = 10;  
11 mod_type = "PSK";  
12 [BER_bob, BER_eve, error_bob, error_eve] = ...  
13 CIOD_IM_BER(num_iterations, N, M, P_tot_des, alpha, sigma2,  
14 SNRdB, mod_type);  
15 fprintf("Bob's BER = %1.6f\n", BER_bob);  
16 fprintf("Eve's BER = %1.6f\n", BER_eve);  
17 fprintf("Number of Bob's Bit Errors = %d\n", error_bob);  
18 fprintf("Number of Eve's Bit Errors = %d\n", error_eve);
```

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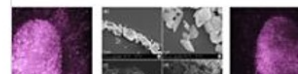
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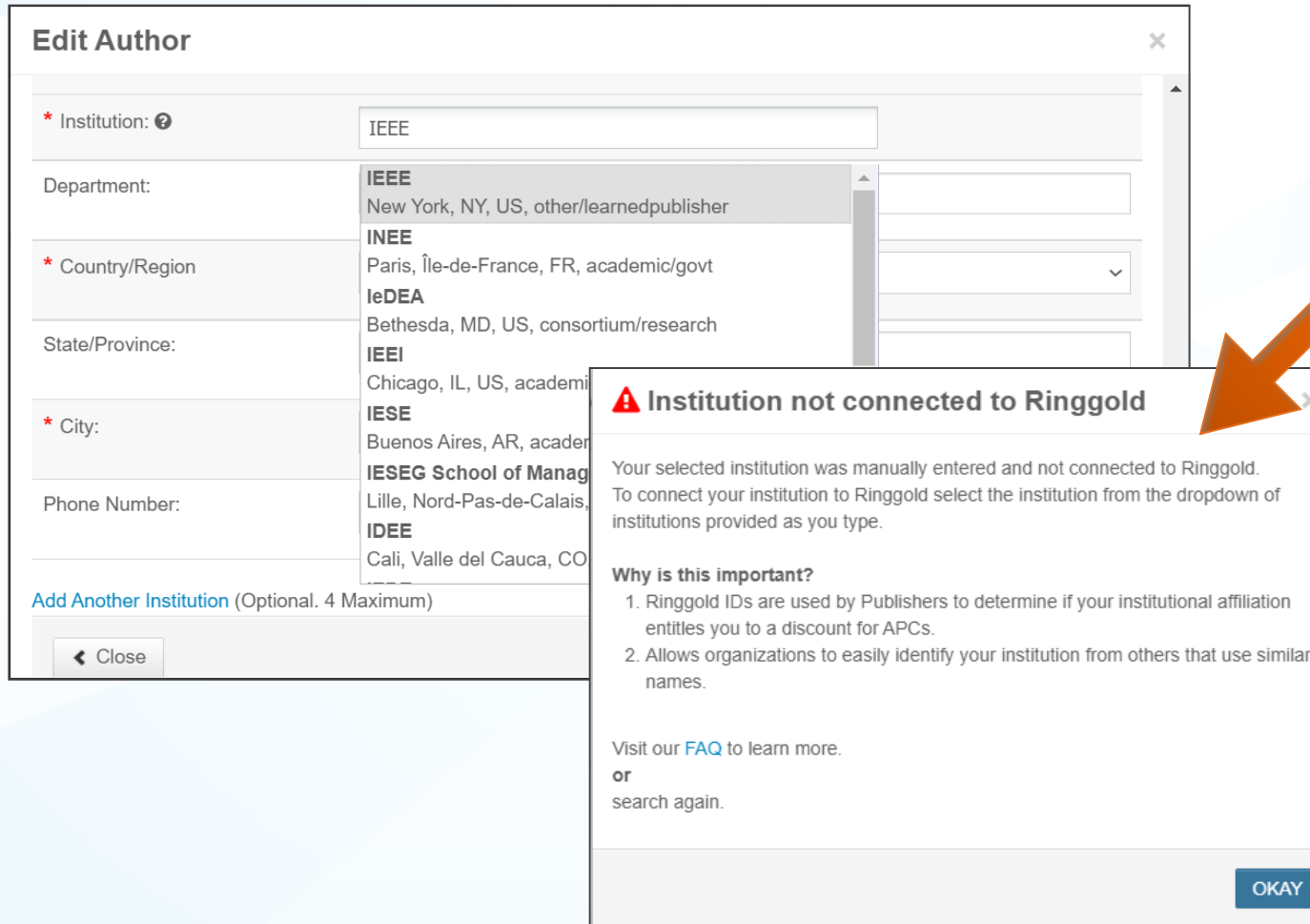
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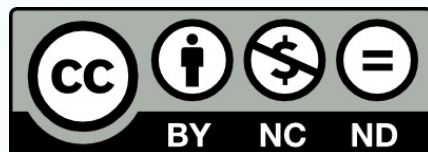
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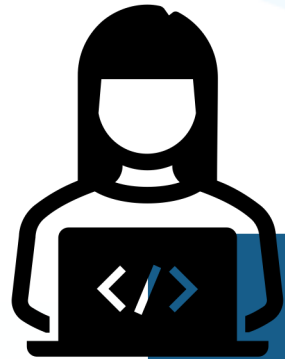


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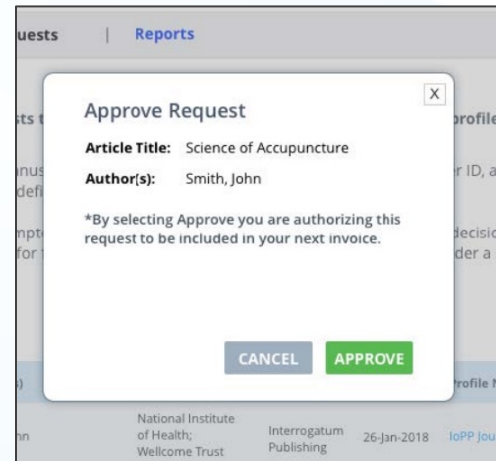
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商店代號：	0	
商店自訂編號：	0	
發票號碼：	1	
隨機碼：	0	
發票金額：	\$	
開立日期：	2	4

欲查看此張發票明細資料，請您點此查看【[發票明細](#)】並自行列印電子發票，ezPay電子發票增值服務平台將不再另行寄送紙本發票。

您也可前往[ezPay電子發票增值中心/幫助中心/查詢專區](#)輸入欲查詢之發票資料，進行單筆發票查詢。

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